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**Embedded - System On Chip (SoC):** The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are **Embedded - System On Chip (SoC)?** 

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

Details	
Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	256KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	1.5GHz
Primary Attributes	FPGA - 270K Logic Elements
Operating Temperature	0°C ~ 100°C (TJ)
Package / Case	780-BBGA, FCBGA
Supplier Device Package	780-FBGA, FC (29x29)
Purchase URL	https://www.e-xfl.com/product-detail/intel/10as027e1f29e1hg

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

### A10-OVERVIEW | 2018.04.09



Feature		Description				
Embedded Hard IP blocks	Variable-precision DSP	<ul> <li>Native support for signal processing precision levels from 18 x 19 to 54 x 54</li> <li>Native support for 27 x 27 multiplier mode</li> <li>64-bit accumulator and cascade for systolic finite impulse responses (FIRs)</li> <li>Internal coefficient memory banks</li> <li>Preadder/subtractor for improved efficiency</li> <li>Additional pipeline register to increase performance and reduce power</li> <li>Supports floating point arithmetic:         <ul> <li>Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication.</li> <li>Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability.</li> <li>Dynamic accumulator reset control.</li> <li>Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks.</li> </ul> </li> </ul>				
	Memory controller	DDR4, DDR3, and DDR3L				
	PCI Express*	PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port				
	Transceiver I/O	10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC)     PCS hard IPs that support:				
Core clock networks	<ul> <li>667 MHz externa</li> <li>800 MHz LVDS in</li> <li>Global, regional, and</li> </ul>	c clocking, depending on the application: I memory interface clocking with 2,400 Mbps DDR4 interface terface clocking with 1,600 Mbps LVDS interface I peripheral clock networks are not used can be gated to reduce dynamic power				
Phase-locked loops (PLLs)	High-resolution fractional synthesis PLLs:  — Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB)  — Support integer mode and fractional mode  — Fractional mode support with third-order delta-sigma modulation  Integer PLLs:  — Adjacent to general purpose I/Os  — Support external memory and LVDS interfaces					
FPGA General-purpose I/Os (GPIOs)	On-chip termination	ry pair can be configured as receiver or transmitter (OCT) -ended LVTTL/LVCMOS interfacing				
External Memory Interface	<ul><li>DDR4—speeds up</li><li>DDR3—speeds up</li></ul>	oller— DDR4, DDR3, and DDR3L support to 1,200 MHz/2,400 Mbps to 1,067 MHz/2,133 Mbps to 1,067 MHz/2,133 Mbps to 1,067 MHz/2,134 Mhz/2,134 Mbps to 1,067 Mhz/2,134				



Feature		Description
Low-power serial transceivers	- Intel Arria 10 GT- Backplane support: - Intel Arria 10 GX- Intel Arria 10 GT- Extended range dow ATX transmit PLLs w Electronic Dispersion module Adaptive linear and of	—1 Gbps to 17.4 Gbps —1 Gbps to 25.8 Gbps —up to 12.5
HPS (Intel Arria 10 SX devices only)	Processor and system	Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability  256 KB on-chip RAM and 64 KB on-chip ROM  System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers  Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA)  ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage
	External interfaces	Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller     Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-GO (OTG) controllers, I²C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os)
	Interconnects to core	High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller
Configuration	Enhanced 256-bit ad	comprehensive design protection to protect your valuable IP investments dvanced encryption standard (AES) design security with authentication obtocol (CvP) using PCIe Gen1, Gen2, or Gen3
		continued

 $<sup>^{(2)}</sup>$  Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



Feature	Description
	<ul> <li>Dynamic reconfiguration of the transceivers and PLLs</li> <li>Fine-grained partial reconfiguration of the core fabric</li> <li>Active Serial x4 Interface</li> </ul>
Power management	SmartVID     Low static power device options     Programmable Power Technology     Intel Quartus Prime integrated power analysis
Software and tools	<ul> <li>Intel Quartus Prime design suite</li> <li>Transceiver toolkit</li> <li>Platform Designer system integration tool</li> <li>DSP Builder for Intel FPGAs</li> <li>OpenCL™ support</li> <li>Intel SoC FPGA Embedded Design Suite (EDS)</li> </ul>

### **Related Information**

Intel Arria 10 Transceiver PHY Overview

Provides details on Intel Arria 10 transceivers.

## **Intel Arria 10 Device Variants and Packages**

#### Table 4. **Device Variants for the Intel Arria 10 Device Family**

Variant	Description
Intel Arria 10 GX	FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.
Intel Arria 10 GT	<ul> <li>FPGA featuring:</li> <li>17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.</li> <li>25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules.</li> </ul>
Intel Arria 10 SX	SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.

## **Intel Arria 10 GX**

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

## **Related Information**

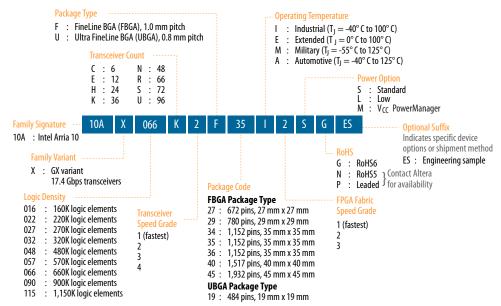
Intel FPGA Product Selector

Provides the latest information on Intel products.



## **Available Options**

Figure 1. Sample Ordering Code and Available Options for Intel Arria 10 GX Devices



### **Related Information**

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



Table 6. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)

Re	source		Produc	t Line	
		GX 570	GX 660	GX 900	GX 1150
Logic Elements	s (LE) (K)	570	660	900	1,150
ALM		217,080	251,680	339,620	427,200
Register		868,320	1,006,720	1,358,480	1,708,800
Memory (Kb)	M20K	36,000	42,620	48,460	54,260
	MLAB	5,096	5,788	9,386	12,984
Variable-precision DSP Block		1,523	1,687	1,518	1,518
18 x 19 Multip	lier	3,046	3,374	3,036	3,036
PLL	Fractional Synthesis	16	16	32	32
	I/O	16	16	16	16
17.4 Gbps Trai	nsceiver	48	48	96	96
GPIO (3)		696	696	768	768
LVDS Pair (4)		324	324	384	384
PCIe Hard IP Block		2	2	4	4
Hard Memory	Controller	16	16	16	16

## **Package Plan**

## Table 7. Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)			(19 mm × 19 mm, (27 mm × 27 mm,					F29 (29 mm × 29 mm, 780-pin FBGA)			
	3 V I/O	LVDS I/O	XCVR	3 V I/O LVDS I/O XCVR			3 V I/O	LVDS I/O	XCVR			
GX 160	48	192	6	48	192	12	48	240	12			
GX 220	48	192	6	48	192	12	48	240	12			
GX 270	_	_	_	48	192	12	48	312	12			
GX 320	_	_	_	48	192	12	48	312	12			
GX 480	_	_	_	_	_	_	48	312	12			



#### **Related Information**

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

## **Intel Arria 10 SX**

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

#### **Related Information**

Intel FPGA Product Selector

Provides the latest information on Intel products.

## **Available Options**

Figure 3. Sample Ordering Code and Available Options for Intel Arria 10 SX Devices



#### **Related Information**

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



### **Maximum Resources**

Table 12. Maximum Resource Counts for Intel Arria 10 SX Devices

Reso	ource	Product Line									
		SX 160	SX 220	SX 270	SX 320	SX 480	SX 570	SX 660			
Logic Elements	s (LE) (K)	160	220	270	320	480	570	660			
ALM		61,510	80,330	101,620	119,900	183,590	217,080	251,680			
Register		246,040	321,320	406,480	479,600	734,360	868,320	1,006,720			
Memory (Kb)	M20K	8,800	11,740	15,000	17,820	28,620	36,000	42,620			
	MLAB	1,050	1,690	2,452	2,727	4,164	5,096	5,788			
Variable-precis	sion DSP Block	156	192	830	985	1,368	1,523	1,687			
18 x 19 Multip	lier	312	384	1,660	1,970	2,736	3,046	3,374			
PLL	Fractional Synthesis	6	6	8	8	12	16	16			
	I/O	6	6	8	8	12	16	16			
17.4 Gbps Tra	nsceiver	12	12	24	24	36	48	48			
GPIO (8)		288	288	384	384	492	696	696			
LVDS Pair (9)		120	120	168	168	174	324	324			
PCIe Hard IP Block		1	1	2	2	2	2	2			
Hard Memory Controller		6	6	8	8	12	16	16			
ARM Cortex-As	9 MPCore	Yes	Yes	Yes	Yes	Yes	Yes	Yes			

## **Package Plan**

Table 13. Package Plan for Intel Arria 10 SX Devices (U19, F27, F29, and F34)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)			F27 nm × 27 2-pin FB0			F29 nm × 29 )-pin FB0			F34 nm × 35 2-pin FB		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
SX 160	48	144	6	48	192	12	48	240	12	_	_	_
SX 220	48	144	6	48	192	12	48	240	12	_	_	_
SX 270	_	_	_	48	192	12	48	312	12	48	336	24
SX 320	_	_	_	48	192	12	48	312	12	48	336	24
											contii	nued

 $<sup>^{(8)}</sup>$  The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(9)</sup> Each LVDS I/O pair can be used as differential input or output.



## I/O Vertical Migration for Intel Arria 10 Devices

### Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use
  memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to
  banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

Variant	Product						Package	e				
variant	Line	U19	F27	F29	F34	F35	KF40	NF40	RF40	NF45	SF45	UF45
	GX 160	<b>1</b>	<b>1</b>	<b>1</b>								
	GX 220	<b>+</b>										
	GX 270				1	<b>1</b>						
	GX 320		<b>V</b>									
Intel® Arria® 10 GX	GX 480			<b>V</b>								
	GX 570						<b>1</b>	1				
	GX 660					<b>V</b>	<b>\</b>					
	GX 900								1	1	<b></b>	1
	GX 1150				<b>V</b>			<b>+</b>	+	+		<b>+</b>
Intel Arria 10 GT	GT 900											
intel Afria 10 G1	GT 1150										<b>V</b>	
	SX 160	1	1	1								
	SX 220	+										
	SX 270				1	<b>†</b>						
Intel Arria 10 SX	SX 320		<b>V</b>									
	SX 480			<b>V</b>								
	SX 570						<b>†</b>	<b>†</b>				
	SX 660				<b>*</b>							

Note:

To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

## **Adaptive Logic Module**

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.

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Features for floating-point arithmetic:

- A completely hardened architecture that supports multiplication, addition, subtraction, multiply-add, and multiply-subtract
- Multiplication with accumulation capability and a dynamic accumulator reset control
- Multiplication with cascade summation capability
- Multiplication with cascade subtraction capability
- Complex multiplication
- Direct vector dot product
- Systolic FIR filter

Table 15. Variable-Precision DSP Block Configurations for Intel Arria 10 Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resources
Medium precision fixed point	Two 18 x 19	1
High precision fixed or Single precision floating point	One 27 x 27	1
Fixed point FFTs	One 19 x 36 with external adder	1
Very high precision fixed point	One 36 x 36 with external adder	2
Double precision floating point	One 54 x 54 with external adder	4

### Table 16. Resources for Fixed-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

Variant	<b>Product Line</b>	Variable- precision DSP Block		nput and Output ons Operator	18 x 19 Multiplier Adder Sum	18 x 18 Multiplier Adder
		DSP BIOCK	18 x 19 Multiplier	27 x 27 Multiplier	Mode Mode	Summed with 36 bit Input
AIntel Arria 10	GX 160	156	312	156	156	156
GX	GX 220	192	384	192	192	192
	GX 270	830	1,660	830	830	830
	GX 320	984	1,968	984	984	984
	GX 480	1,368	2,736	1,368	1,368	1,368
	GX 570	1,523	3,046	1,523	1,523	1,523
	GX 660	1,687	3,374	1,687	1,687	1,687
	GX 900	1,518	3,036	1,518	1,518	1,518
	GX 1150	1,518	3,036	1,518	1,518	1,518
Intel Arria 10 GT	GT 900	1,518	3,036	1,518	1,518	1,518
GI	GT 1150	1,518	3,036	1,518	1,518	1,518
Intel Arria 10	SX 160	156	312	156	156	156
SX	SX 220	192	384	192	192	192
	SX 270	830	1,660	830	830	830
						continued



Variant	Product Line	Variable- precision	Independent In Multiplication		18 x 19 Multiplier Adder Sum Mode	18 x 18 Multiplier Adder	
		DSP Block	18 x 19 Multiplier	27 x 27 Multiplier		Summed with 36 bit Input	
	SX 320	984	1,968	984	984	984	
	SX 480	1,368	2,736	1,368	1,368	1,368	
	SX 570	1,523	3,046	1,523	1,523	1,523	
	SX 660	1,687	3,374	1,687	1,687	1,687	

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

Variant	Product Line	Variable- precision DSP Block	Single Precision Floating-Point Multiplication Mode	Single-Precision Floating-Point Adder Mode	Single- Precision Floating-Point Multiply Accumulate Mode	Peak Giga Floating- Point Operations per Second (GFLOPs)
Intel Arria 10	GX 160	156	156	156	156	140
GX	GX 220	192	192	192	192	173
	GX 270	830	830	830	830	747
	GX 320	984	984	984	984	886
	GX 480	1,369	1,368	1,368	1,368	1,231
	GX 570	1,523	1,523	1,523	1,523	1,371
	GX 660	1,687	1,687	1,687	1,687	1,518
	GX 900	1,518	1,518	1,518	1,518	1,366
	GX 1150	1,518	1,518	1,518	1,518	1,366
Intel Arria 10	GT 900	1,518	1,518	1,518	1,518	1,366
GT	GT 1150	1,518	1,518	1,518	1,518	1,366
Intel Arria 10	SX 160	156	156	156	156	140
SX	SX 220	192	192	192	192	173
	SX 270	830	830	830	830	747
	SX 320	984	984	984	984	886
	SX 480	1,369	1,368	1,368	1,368	1,231
	SX 570	1,523	1,523	1,523	1,523	1,371
	SX 660	1,687	1,687	1,687	1,687	1,518

## **Embedded Memory Blocks**

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



- Series (R<sub>S</sub>) and parallel (R<sub>T</sub>) on-chip termination (OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture

## **External Memory Interface**

Intel Arria 10 devices offer massive external memory bandwidth, with up to seven 32-bit DDR4 memory interfaces running at up to 2,400 Mbps. This bandwidth provides additional ease of design, lower power, and resource efficiencies of hardened high-performance memory controllers.

The memory interface within Intel Arria 10 FPGAs and SoCs delivers the highest performance and ease of use. You can configure up to a maximum width of 144 bits when using the hard or soft memory controllers. If required, you can bypass the hard memory controller and use a soft controller implemented in the user logic.

Each I/O contains a hardened DDR read/write path (PHY) capable of performing key memory interface functionality such as read/write leveling, FIFO buffering to lower latency and improve margin, timing calibration, and on-chip termination.

The timing calibration is aided by the inclusion of hard microcontrollers based on Intel's Nios® II technology, specifically tailored to control the calibration of multiple memory interfaces. This calibration allows the Intel Arria 10 device to compensate for any changes in process, voltage, or temperature either within the Intel Arria 10 device itself, or within the external memory device. The advanced calibration algorithms ensure maximum bandwidth and robust timing margin across all operating conditions.

In addition to parallel memory interfaces, Intel Arria 10 devices support serial memory technologies such as the Hybrid Memory Cube (HMC). The HMC is supported by the Intel Arria 10 high-speed serial transceivers which connect up to four HMC links, with each link running at data rates up to 15 Gbps.

#### **Related Information**

## External Memory Interface Spec Estimator

Provides a parametric tool that allows you to find and compare the performance of the supported external memory interfaces in IntelFPGAs.

## **Memory Standards Supported by Intel Arria 10 Devices**

The I/Os are designed to provide high performance support for existing and emerging external memory standards.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices

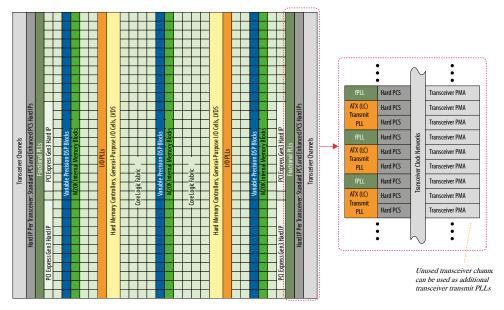
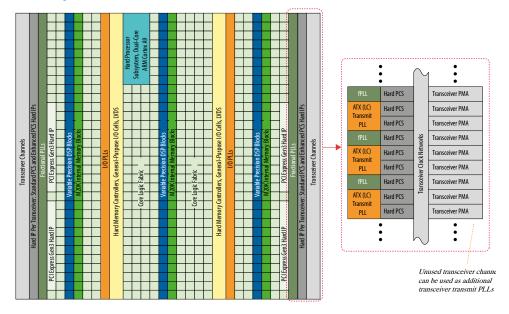


Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



## **PMA Features**

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



#### Features of the HPS

The HPS has the following features:

- 1.2-GHz, dual-core ARM Cortex-A9 MPCore processor with up to 1.5-GHz via overdrive
  - ARMv7-A architecture that runs 32-bit ARM instructions, 16-bit and 32-bit
     Thumb instructions, and 8-bit Java byte codes in Jazelle style
  - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction
  - Instruction Efficiency 2.5 MIPS/MHz, which provides total performance of 7500 MIPS at 1.5 GHz
- Each processor core includes:
  - 32 KB of L1 instruction cache, 32 KB of L1 data cache
  - Single- and double-precision floating-point unit and NEON media engine
  - CoreSight debug and trace technology
  - Snoop Control Unit (SCU) and Acceleration Coherency Port (ACP)
- 512 KB of shared L2 cache
- 256 KB of scratch RAM
- Hard memory controller with support for DDR3, DDR4 and optional error correction code (ECC) support
- Multiport Front End (MPFE) Scheduler interface to the hard memory controller
- 8-channel direct memory access (DMA) controller
- QSPI flash controller with SIO, DIO, QIO SPI Flash support
- NAND flash controller (ONFI 1.0 or later) with DMA and ECC support, updated to support 8 and 16-bit Flash devices and new command DMA to offload CPU for fast power down recovery
- Updated SD/SDIO/MMC controller to eMMC 4.5 with DMA with CE-ATA digital command support
- 3 10/100/1000 Ethernet media access control (MAC) with DMA
- 2 USB On-the-Go (OTG) controllers with DMA
- 5 I<sup>2</sup>C controllers (3 can be used by EMAC for MIO to external PHY)
- 2 UART 16550 Compatible controllers
- 4 serial peripheral interfaces (SPI) (2 Master, 2 Slaves)
- 62 programmable general-purpose I/Os, which includes 48 direct share I/Os that allows the HPS peripherals to connect directly to the FPGA I/Os
- 7 general-purpose timers
- 4 watchdog timers
- Anti-tamper, Secure Boot, Encryption (AES) and Authentication (SHA)



### **System Peripherals and Debug Access Port**

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

## **HPS-FPGA AXI Bridges**

The HPS-FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI $^{\text{\tiny M}}$ ) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows
  the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is
  primarily used for control and status register (CSR) accesses to peripherals in the
  FPGA fabric.

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS-FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

## **HPS SDRAM Controller Subsystem**

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



## **FPGA Configuration and HPS Booting**

The FPGA fabric and HPS in the SoC FPGA must be powered at the same time. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.

Once powered, the FPGA fabric and HPS can be configured independently thus providing you with more design flexibility:

- You can boot the HPS independently. After the HPS is running, the HPS can fully or
  partially reconfigure the FPGA fabric at any time under software control. The HPS
  can also configure other FPGAs on the board through the FPGA configuration
  controller.
- Configure the FPGA fabric first, and then boot the HPS from memory accessible to the FPGA fabric.

## **Hardware and Software Development**

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer system integration tool in the Intel Quartus Prime software.

For software development, the ARM-based SoC FPGA devices inherit the rich software development ecosystem available for the ARM Cortex-A9 MPCore processor. The software development process for Intel SoC FPGAs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux\*, VxWorks\*, and other operating systems are available for the SoC FPGAs. For more information on the operating systems support availability, contact the Intel FPGA sales team.

You can begin device-specific firmware and software development on the Intel SoC FPGA Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

## **Dynamic and Partial Reconfiguration**

The Intel Arria 10 devices support dynamic and partial reconfiguration. You can use dynamic and partial reconfiguration simultaneously to enable seamless reconfiguration of both the device core and transceivers.

## **Dynamic Reconfiguration**

You can reconfigure the PMA and PCS blocks while the device continues to operate. This feature allows you to change the data rates, protocol, and analog settings of a channel in a transceiver bank without affecting on-going data transfer in other transceiver banks. This feature is ideal for applications that require dynamic multiprotocol or multirate support.

## **Partial Reconfiguration**

Using partial reconfiguration, you can reconfigure some parts of the device while keeping the device in operation.



Scheme	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompression	Design Security <sup>(1</sup> 4)	Partial Reconfiguration (15)	Remote System Update
Fast passive	8 bits	100	3200	Yes	Yes	Yes <sup>(17)</sup>	PFL IP
parallel (FPP) through CPLD or	16 bits			Yes	Yes		core
external microcontroller	32 bits			Yes	Yes		
Configuration via	16 bits	100	3200	Yes	Yes	Yes <sup>(17)</sup>	_
HPS	32 bits			Yes	Yes		
Configuration via Protocol [CvP (PCIe*)]	x1, x2, x4, x8 lanes	_	8000	Yes	Yes	Yes <sup>(16)</sup>	_

You can configure Intel Arria 10 devices through PCIe using Configuration via Protocol (CvP). The Intel Arria 10 CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

### **SEU Error Detection and Correction**

Intel Arria 10 devices offer robust and easy-to-use single-event upset (SEU) error detection and correction circuitry.

The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running CRC error detection circuit with integrated ECC that automatically corrects one or two errors and detects higher order multi-bit errors. When more than two errors occur, correction is available through reloading of the core programming file, providing a complete design refresh while the FPGA continues to operate.

The physical layout of the Intel Arria 10 CRAM array is optimized to make the majority of multi-bit upsets appear as independent single-bit or double-bit errors which are automatically corrected by the integrated CRAM ECC circuitry. In addition to the CRAM protection, the M20K memory blocks also include integrated ECC circuitry and are layout-optimized for error detection and correction. The MLAB does not have ECC.

## **Power Management**

Intel Arria 10 devices leverage the advanced 20 nm process technology, a low 0.9 V core power supply, an enhanced core architecture, and several optional power reduction techniques to reduce total power consumption by as much as 40% compared to Arria V devices and as much as 60% compared to Stratix V devices.

<sup>(13)</sup> Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

<sup>(14)</sup> Encryption and compression cannot be used simultaneously.

<sup>(15)</sup> Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

<sup>(17)</sup> Supported at a maximum clock rate of 100 MHz.



The optional power reduction techniques in Intel Arria 10 devices include:

- SmartVID—a code is programmed into each device during manufacturing that allows a smart regulator to operate the device at lower core V<sub>CC</sub> while maintaining performance
- **Programmable Power Technology**—non-critical timing paths are identified by the Intel Quartus Prime software and the logic in these paths is biased for low power instead of high performance
- **Low Static Power Options**—devices are available with either standard static power or low static power while maintaining performance

Furthermore, Intel Arria 10 devices feature Intel's industry-leading low power transceivers and include a number of hard IP blocks that not only reduce logic resources but also deliver substantial power savings compared to soft implementations. In general, hard IP blocks consume up to 90% less power than the equivalent soft logic implementations.

## **Incremental Compilation**

The Intel Quartus Prime software incremental compilation feature reduces compilation time and helps preserve performance to ease timing closure. The incremental compilation feature enables the partial reconfiguration flow for Intel Arria 10 devices.

Incremental compilation supports top-down, bottom-up, and team-based design flows. This feature facilitates modular, hierarchical, and team-based design flows where different designers compile their respective design sections in parallel. Furthermore, different designers or IP providers can develop and optimize different blocks of the design independently. These blocks can then be imported into the top level project.

# **Document Revision History for Intel Arria 10 Device Overview**

Document Version	Changes
2018.04.09	Updated the lowest $V_{CC}$ from 0.83 V to 0.82 V in the topic listing a summary of the device features.

Date	Version	Changes
January 2018	2018.01.17	Updated the maximum data rate for HPS (Intel Arria 10 SX devices external memory interface DDR3 controller from 2,166 Mbps to 2,133 Mbps.
		Updated maximum frequency supported for half rate QDRII and QDRII     + SRAM to 633 MHz in Memory Standards Supported by the Soft     Memory Controller table.
		Updated transceiver backplane capability to 12.5 Gbps.
		Removed transceiver speed grade 5 in Sample Ordering Core and Available Options for Intel Arria 10 GX Devices figure.
	·	continued

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September 2017  July 2017  July 2017  May 2017	2017.09.20 2017.07.13 2017.07.06 2017.05.08	<ul> <li>Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from Sample Ordering Core and Available Options for Intel Arria 10 GT Devices figure.</li> <li>Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps.</li> <li>Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from PMA Features of the Transceivers in Intel Arria 10 Devices table.</li> <li>Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.</li> <li>Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".</li> <li>Added automotive temperature option to Intel Arria 10 GX device family.</li> </ul>
July 2017 July 2017	2017.07.13	1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.  Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".  Added automotive temperature option to Intel Arria 10 GX device family.
July 2017	2017.07.06	available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".  Added automotive temperature option to Intel Arria 10 GX device family.
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May 2017	2017.05.08	
		<ul> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants.</li> <li>Removed all "Preliminary" marks.</li> </ul>
March 2017	2017.03.15	<ul> <li>Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices.</li> <li>Rebranded as Intel.</li> </ul>
October 2016	2016.10.31	<ul> <li>Removed package F36 from Intel Arria 10 GX devices.</li> <li>Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers.</li> </ul>
May 2016	2016.05.02	<ul> <li>Updated the FPGA Configuration and HPS Booting topic.</li> <li>Remove V<sub>CC</sub> PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices.</li> <li>Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA.</li> <li>Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices.</li> </ul>
February 2016	2016.02.11	<ul> <li>Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally.</li> <li>Revised the state for Core clock networks in the Summary of Features topic.</li> <li>Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table.</li> <li>Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table.</li> <li>Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table.</li> <li>Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure.</li> <li>Changed transceiver parameters in the "Low Power Serial Transceivers" section.</li> <li>Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table.</li> <li>Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure.</li> <li>Changed the datarates for GT devices in the "PMA Features" section.</li> <li>Changed the datarates for GT devices in the "PCS Features" section.</li> </ul>



Date	Version	Changes
December 2015	2015.12.14	Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb.
		Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources.
November 2015	2015.11.02	• Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660.
		Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in <b>Number of Multipliers in Intel Arria 10 Devices</b> table.
		<ul> <li>Updated the available options for Arria 10 GX, GT, and SX.</li> <li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li> </ul>
June 2015	2015.06.15	Corrected label for Intel Arria 10 GT product lines in the vertical migration figure.
May 2015	2015.05.15	Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller.
May 2015	2015.05.04	Added support for 13.5G JESD204b in the Summary of Features table.  Added support for 13.5G JESD204b in the Summary of Features table.
		Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic.
		Added a note to the table, Maximum Resource Counts for Arria 10 GT devices.
		Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic.
January 2015	2015.01.23	Added floating point arithmetic features in the Summary of Features table.
		Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb.
		Updated the table that lists the memory standards supported by Intel Arria 10 devices.
		<ul> <li>Removed support for DDR3U, LPDDR3 SDRAM, RLDRAM 2, and DDR2.</li> <li>Moved RLDRAM 3 support from hard memory controller to soft memory controller. RLDRAM 3 support uses hard PHY with soft memory controller.</li> </ul>
		Added soft memory controller support for QDR IV.
		Updated the maximum resource count table to include the number of hard memory controllers available in each device variant.
		Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps.
		Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz.
		Added a feature for fractional synthesis PLLs: PLL cascading.
		Updated the HPS programmable general-purpose I/Os from 54 to 62.
September 2014	2014.09.30	Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX.
		Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660.
		Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150.
		continued

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Date	Version	Changes
August 2014	2014.08.18	Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620.
		Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table.
		Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration.
		Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller.
		Added variable precision DSP blocks support for floating-point arithmetic.
June 2014	2014.06.19	Updated number of dedicated I/Os in the HPS block to 17.
February 2014	2014.02.21	Updated transceiver speed grade options for GT devices in Figure 2.
February 2014	2014.02.06	Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps.
December 2013	2013.12.10	Updated the HPS memory standards support from LPDDR2 to LPDDR3.     Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks .
December 2013	2013.12.02	Initial release.